

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6090133

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DONG WEON HWANG	04/28/2020
LOGAN JAE HWANG	04/28/2020
JAE BAEK HWANG	04/28/2020
RECEIVING PARTY DATA	
Name:	HICON CO., LTD.
Street Address:	9F., 37, SAGIMAKGOL-RO 62BEON-GIL
Internal Address:	JUNGWON-GU, SEONGNAM-SI
City:	GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	13211
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16865821
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	42497-122391US
NAME OF SUBMITTER:	SUN Y. PAE
SIGNATURE:	/Sun Y. Pae/
DATE SIGNED:	05/04/2020
Total Attachments: 2	
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source=PF-E1714-2020-05-04-Assignment (executed) (122391US)#page2.tif	

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ASSIGNMENT

WHEREAS, I/we, the following inventor(s) with the following mailing address(es), Dong Weon Hwang, 85, Dumil-ro 123beon-gil, Bundang-gu, Seongnam-si, Gyeonggi-do 13544, Republic of Korea, Logan Jae Hwang, 2809 Merryglen Ln, Flower Mound, Texas 75022, US, Jae Baek Hwang, #74-503, 201, Apgujeong-ro, Gangnam-gu, Seoul 06004, Republic of Korea, (collectively, "Assignor") have invented new and useful improvements in **SPRING CONTACT AND TEST SOCKET WITH SAME**, and have executed the above-identified application for United States Letters Patent for the same; and

WHEREAS, HICON CO., LTD., an entity organized and existing under the laws of the Republic of Korea with an address at 9F., 37, Sagimakgol-ro 62beon-gil, Jungwon-gu, Seongnam-si, Gyeonggi-do 13211, Republic of Korea, (collectively, "Assignee") is desirous of acquiring the entire right, title, and interest in and to said invention and said application, and in to and under all Letters Patent and similar patent rights of the United States and foreign countries that may be granted therefor;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignor does hereby sell, assign, transfer and set over unto Assignee, its successors and assigns, for, within and throughout the United States and its territories, and all foreign countries, the full and exclusive right, title and interest in and to such invention, application, and all Letters Patent and similar patent rights of the United States and foreign countries that may be granted therefor, including divisions, continuations, reissues, subdivisions, renewals and extensions thereof, to hold for the sole and exclusive use and benefit of Assignee, its successors and assigns, to the full end of the term or terms thereof, and further, including the right to Assignee to file in Assignee's name applications for Letters Patent and similar patent rights in any country or countries foreign to the United States including the full right to claim for any such applications the priority benefits of the International Convention for the Protection of Industrial Property (also known as the Paris Convention) and other priority conferring treaties, and all Letters Patent and similar patent rights which may be granted therefor in any country or countries foreign to the United States and all divisions, reissues, subdivisions, renewals and extensions thereof.

Assignor does hereby covenant and agree, for Assignor and Assignor's heirs and legal representatives, that Assignor will assist Assignee in the prosecution of the application identified herein; in the making and prosecution of any other applications for Letters Patent and similar patent rights that Assignee may elect to make covering the invention herein identified, as hereinbefore set forth; in vesting

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in Assignee, like exclusive title in and to all such other applications and Letters Patent and similar patent rights; and in the prosecution of any interference or similar action which may arise involving such invention, or any application or Letters Patent or similar patent rights herein contemplated; and that Assignor will execute and deliver to Assignee, any and all additional papers, and take any further actions, that may be requested by Assignee, to fully carry out the terms of this assignment.

And Assignor does hereby authorize and request the Commissioner of Patents to issue all Letters Patent of the United States to Assignee, its successors and assigns, in accordance with this assignment.

And Assignor hereby covenants that Assignor has full right to convey the entire interest herein assigned, and that Assignor has not executed and will not execute any agreement in conflict herewith.

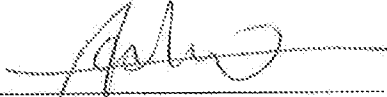
And Assignor hereby authorizes and requests Assignor's and/or Assignee's attorneys to insert above any information identifying the application to which this assignment pertains, or any related application(s), including divisions, continuations, reissues, subdivisions, renewals and extensions thereof, when known, after execution of this assignment.

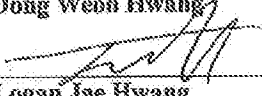
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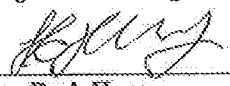
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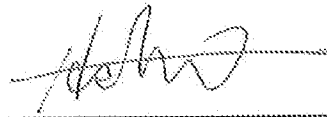
Dong Weon Hwang


Logan Jae Hwang


Jae Back Hwang

Assignee:

04.28.2020
Date: _____



Name: Dong Weon HWANG
Title: C.E.O.
For: HICON CO., LTD.